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Vishay Siliconix

P-Channel 60 V (D-S) 175 °C MOSFET

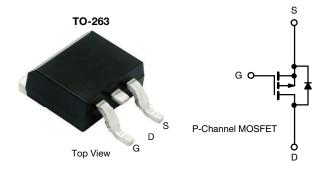
PRODUCT SUMMARY				
V _{DS} (V)	$V_{DS}(V)$ $R_{DS(on)}(\Omega)$			
-60	0.0069 at V _{GS} = -10 V	-110		
-00	0.0088 at V _{GS} = -4.5 V	-110		

FEATURES

- TrenchFET® power MOSFET
- Package with low thermal resistance



 Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



Ordering Information:

SUM110P06-07L-E3 (Lead (Pb)-free)

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V_{DS}	-60	.,,		
Gate-Source Voltage	V_{GS}	± 20	V		
Continuous Drain Current d	T _C = 25 °C	,	-110		
$(T_{J} = 175 ^{\circ}C)$	T _C = 125 °C	I _D	-95		
Pulsed Drain Current		I _{DM}	-240	A	
Avalanche Current	1 04 ::11		-75		
Single Pulse Avalanche Energy ^a	L = 0.1 mH	E _{AS}	281	mJ	
Dawer Dissination	T _C = 25 °C °	В	375	W	
Power Dissipation	T _A = 25 °C b	P _D	3.75		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	UNIT		
Junction-to-Ambient	PCB mount ^b	R_{thJA}	40	°C/W		
Junction-to-Case		R _{thJC}	0.4	C/VV		

Notes

- a. Duty cycle ≤ 1 %.
- b. When mounted on 1" square PCB (FR4 material).
- c. See SOA curve for voltage derating.
- d. Limited by package.



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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-60	-	-	V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	- V _{GS} , I _D = -250 μA -1 -		-3	7 V
Gate-Body Leakage I _{GSS}		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
		V _{DS} = -60 V, V _{GS} = 0 V	-	-	-1	μA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -60 V, V _{GS} = 0 V, T _J = 125 °C	-	-	-50	
		V _{DS} = -60 V, V _{GS} = 0 V, T _J = 175 °C	-	-	-250	
On-State Drain Current ^a			-120	-	-	Α
		$V_{GS} = -10 \text{ V}, I_D = -30 \text{ A}$	-	0.0055	0.0069	Ω
Drain Course On State Registeres 3		V _{GS} = -10 V, I _D = -30 A, T _J = 125 °C	-	-	0.0115	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = -10 V, I _D = -30 A, T _J = 175 °C	-	-	0.0138	
		$V_{GS} = -4.5 \text{ V}, I_D = -20 \text{ A}$	-	0.0070	0.0088	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = -15 \text{ V}, I_D = -50 \text{ A}$	20	-	-	S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = -25 V, f = 1 MHz	-	11 400	-	pF
Output Capacitance	Coss		-	1200	-	
Reverse Transfer Capacitance	C _{rss}		-	900	-	
Total Gate Charge c	Qg		-	230	345	nC
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -110 \text{ A}$	-	50	-	
Gate-Drain Charge ^c	Q_{gd}		-	60	-	
Gate Resistance	R_g	f = 1 MHz	-	3	-	Ω
Turn-On Delay Time ^c	t _{d(on)}		-	20	30	
Rise Time ^c	t _r	$V_{DD} = -30 \text{ V}, R_1 = 0.27 \Omega$	-	25	40	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -110 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	110	200	ns
Fall Time ^c	t _f		-	50	100	
Drain-Source Body Diode Character	istics (T _C = 25	5 °C b)				
Continuous Current	Is		-	-	-110	^
Pulsed Current	I _{SM}		-	-	-240	A
Forward Voltage ^a	V_{SD}	I _F = -85 A, V _{GS} = 0 V	-	-1	-1.5	V
Reverse Recovery Time	t _{rr}		-	91	137	ns
Peak Reverse Recovery Charge	I _{RM(REC)}	I _F = -85 A, dl/dt = 100 A/μs	-	-6	-9	Α
Reverse Recovery Charge			-	0.21	0.44	μC

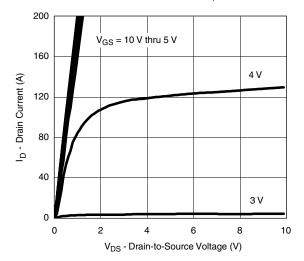
Notes

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

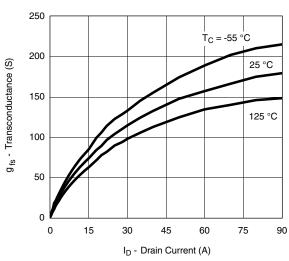
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



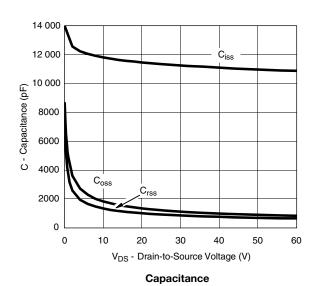
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

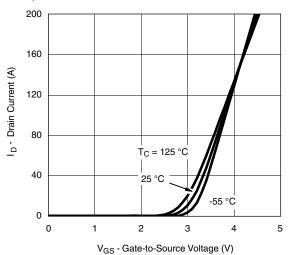


Output Characteristics

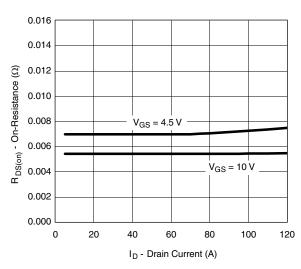


Transconductance

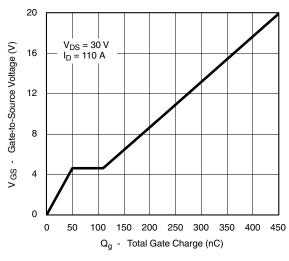




Transfer Characteristics

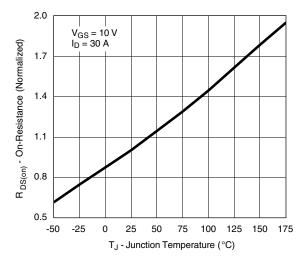


On-Resistance vs. Drain Current

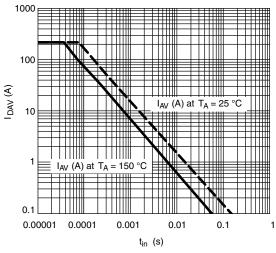




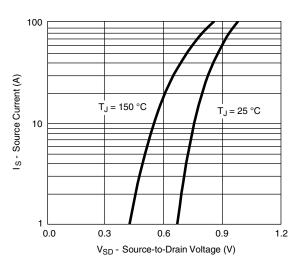
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



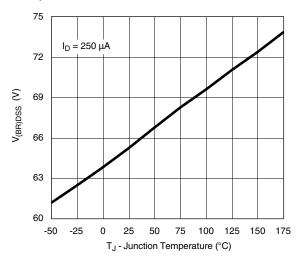
On-Resistance vs. Junction Temperature



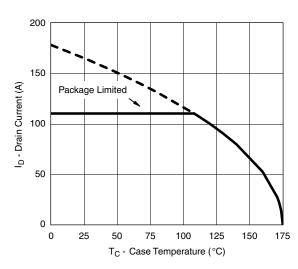
Avalanche Current vs. Time



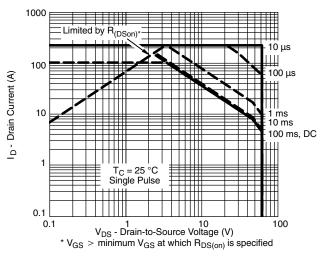
Source-Drain Diode Forward Voltage



Drain Source Breakdown vs. Junction Temperature



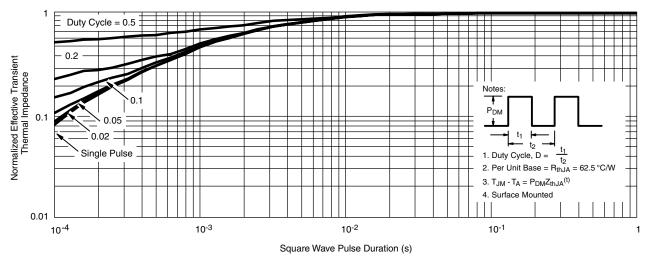
Maximum Avalanche and Drain Current vs. Case Temperature



Safe Operating Area



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

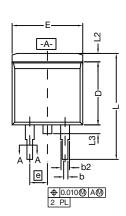


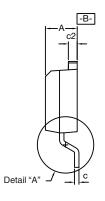
Normalized Thermal Transient Impedance, Junction-to-Case

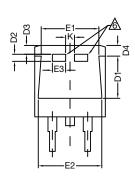
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TO-263 (D²PAK): 3-LEAD

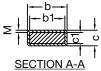








DETAIL A (ROTATED 90°)



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- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6. This feature is for thick lead.

DIM.		INC	HES	MILLIMETERS		
		MIN.	MAX.	MIN.	MAX.	
Α		0.160	0.190	4.064	4.826	
b		0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
c*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
	D2	0.038	0.042	0.965	1.067	
	D3	0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	Е	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	=	
	E2	0.355	0.375	9.017	9.525	
	E3	0.072	0.078	1.829	1.981	
	е	0.100) BSC	2.54 BSC		
K		0.045	0.055	1.143	1.397	
L		0.575	0.625	14.605	15.875	
L1		0.090	0.110	2.286	2.794	
L2		0.040	0.055	1.016	1.397	
L3		0.050	0.070	1.270	1.778	
	L4	0.010) BSC	0.254 BSC		
M		-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13						

DWG: 5843





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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